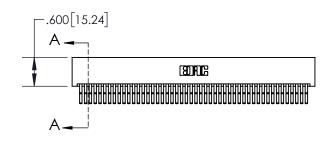
Contact Dimensions:

560-Extender Board Bend (Code 523 Contacts) See Sheet 2 for Contact Code 555, 556, 558, 559, 560 Dimensions

1

-5.060 [128.52] 4.900 [124.46] .100 [2.54] CARD SLOT ACCEPTS -.054" [1.37] TO .070"[1.78] THICK PCB



.330[8.38] **CARD SLOT** .370 [9.40] **SECTION A-A** .160 4.06 POINT OF **CONTACT -**.200 [5.08]

- INSULATOR MATERIAL: THERMOPLASTIC, UL 94V-0
- CONTACT MATERIAL; COPPER TIN ALLOY CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SE	ERIES HIGH TEMF	CARD	EDGE	CONNECT	OR
PART NUM	IBFR: 895-096-56	0-201			

YOUR CONNECTION TO QUALITY & SERVICE

ACAD REFERENCE NO	. 845-ENG-MASTER
DRAWN: R.STA.MONICA	DATE:MAY.16/2017
CHECKED:	DATE:
SCALE: 1:2	SHEET 1 OF 2
DRAWING NUMBER	ISSUE

845-ENG-MASTER







- INSULATOR MATERIAL: THERMOPLASTIC POLYESTER, UL 94V-0 DAP MATERIAL AVAILABLE UPON REQUEST
- CONTACT MATERIAL; COPPER ALLOY

CONTACT PLATING: GOLD ON THE MATING AREA, TIN PLATING ON THE CONTACT TAILS, NICKEL UNDERPLATE

845/895 SERIES HIGH TEMP CARD EDGE CONNECTOR CONTACT CODE 555,556,558,559,560 DIMENSIONS

YOUR CONNECTION TO QUALITY & SERVICE

	ACAD REFERENCE NO	. 845-ENG-MASTER			
	DRAWN: R.STA.MONICA	DATE:MAY.16/2017			
	CHECKED:	DATE:			
	SCALE: 1:1	SHEET 2 OF 2			
D	DRAWING NUMBER	ISSUE			

845-ENG-MASTER